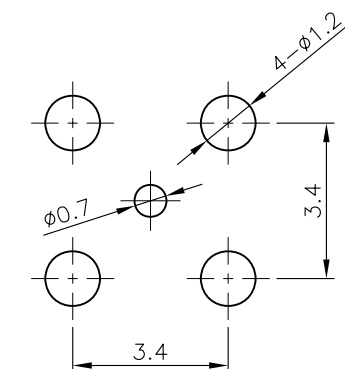
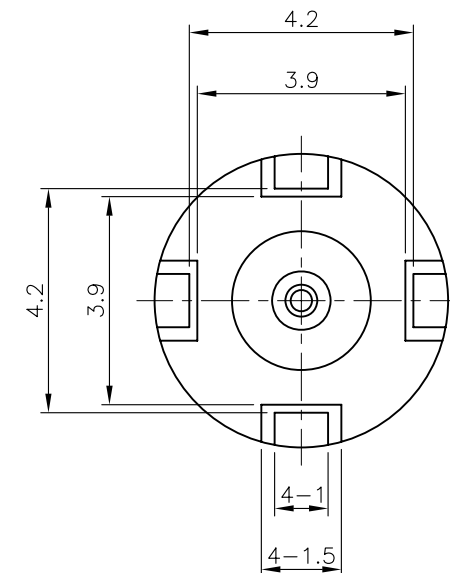
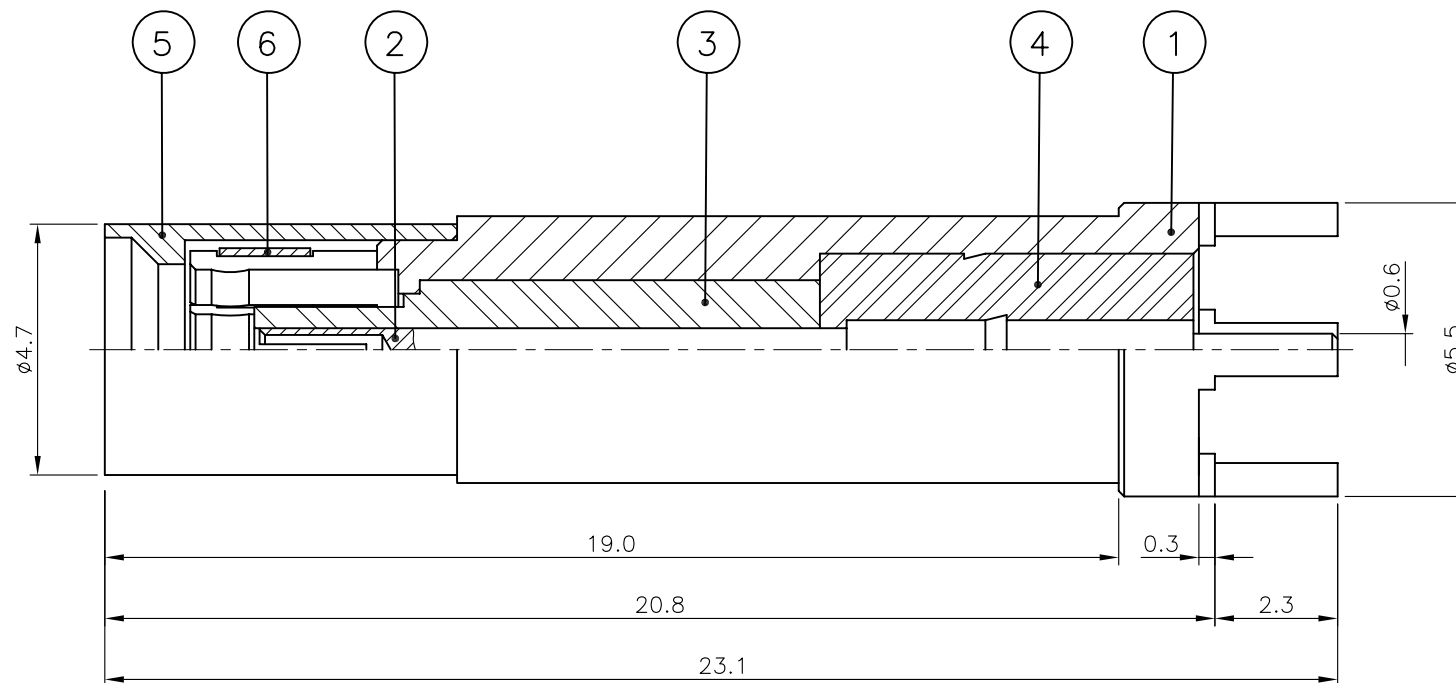


REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	J.H.YOUN	2012.03.02.



PCB MOUNTING HOLE

NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
6	SPRING RING	1	BeCu	Nickel Plate	DSR00037-5/2
5	CAP	1	MBsBD	Nickel Plate	DCU02187-5/1
4	INSULATOR	1	TEFLON		DIN01982-N/1
3	INSULATOR	1	TEFLON		DIN01981-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02559-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD03029-5/1

TOLERANCE	Decimal	DATE	2012. 03. 02.
	Angle	APPROVED BY	J.H.YOUN
MATERIAL		CHECKED BY	
		DRAWN BY	I.C.KIM
FINISH		SCALE	7/1
		UNIT	mm



RF & MICROWAVE
TECHNOLOGY
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Fax : 82-32-347-8017

TITLE
SMF50 trans PCB JS-4R

DWG NO.	CN02772-7/1
REVISION	I R
SHEET	1 of 1